Frontiers of Experimental Condensed Matter Physics

Part C, Atomic scale measurements: Part II: Electron Microscopy

- Background and instrumentation
 - Scanning: SEM
 - Transmission:
 - >TEM
 - STEM
- Imaging and Contrast
 - > Optics, Resolution limits
 - Scattering mechanisms
- Variable pressure SEM
- Analytical microscopy
 - > EELS
 - >EDX
- Recent developments
 - Atomic resolution: aberration correction
 - >3-D microscopy

General ref: Williams and Carter "Transmission electron microscopy", Plenum Press (1996) – a comprehensive source used for many figures here. ₁

Background

History

After optical microscopy, electron microscopy is the most established

microscopic method. There is ~70 years development since the first microscope and the subject is complex and detailed.

Methods:

Different approaches arise from the many scattering and excitation processes.



- Elastic scattering and diffraction mainly in forward direction.
- Inelastic scattering
 - single excitations: in the forward direction
 - >multiple scattering: in all directions
- Secondary electrons –created in the sample by excitation from the primary beam
- Photons arising from excitation by the primary beam

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TEM / SEM

- Observation of forward scattering requires thin samples and hence instruments known as Transmission Electron Microscopes (TEM)
 - The elastically scattered electrons, are coherent and can be imaged directly.
 Thin sample
 - TEMs have the higher resolution (cf SEMs below).

Observation of backscattered processes, from thicker samples.

The image is created by scanning a highly focussed probe across the sample and measuring the

Diffraction

(dark field)

variation of the backscattered signal. Such instruments are Scanning Electron Microscopes (SEM).



Transmission

(Bright field)

Inelastic

(EELS)

The earliest successful instrument was constructed in the Engineering Department at Cambridge ~1952 (McMullan)

N.B. The STEM combines scanning and transmission methods.

Resolution

Factors affecting resolution:

- Probe size (which depends on the electron gun and electron energy), aberration of lenses, and diffraction at apertures.
- Similar criteria limit both SEM and TEM instruments

Aberrations

- Spherical aberrations:
 - Saussian focus is defined as the crossing point for rays in the limit $\alpha \rightarrow 0$.

Lens Gaussian focus $=C_s \alpha^3$

As α increases, electron lenses "over-focus" and the crossing point moves to smaller *x*. The *y*-coordinate at the Gaussian focus varies like

$$y(\alpha) \approx C_s \alpha^3 + O(\alpha^5)$$

NB This is part of a series expansion of the y coordinate in terms of α . The even order terms in α are zero by symmetry and the coefficient of the α^1 term is zero, since that defines the Gaussian focus.

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Spherical aberration

Note that the "best" focus occurs at the disc of least confusion, slightly away from the Gaussian focus.



The spot size at the "best" focus is taken as



There are other types of aberration (Coma, chromatic etc.); however, spherical aberration is usually the dominant factor.

Diffraction limit; Gun limit

Diffraction

The ultimate focal spot is limited by diffraction. With a circular aperture, the diffraction pattern is an Airy disc (cf IB waves) of diameter.

$$\delta_d \approx 1.22 \lambda/lpha$$

Electron gun

- The size of the electron probe is a compromise between the current, which determines the strength of the signal, and the half-angle of the beam.
- The key characteristic of the source is its brightness, β. i.e.. current emitted, per unit area, per unit solid angle.

$$\beta \approx \frac{i_e}{\pi \alpha^2} \frac{4}{\pi d_g^2} \implies d_g \approx \frac{2}{\pi} \sqrt{\frac{i_e}{\beta} \frac{1}{\alpha}}$$

i.e. for a given current the spot size is inversely proportional to the beam angle, α .

Resolution

- > Adding diameters in quadrature $d^2 = \delta_s^2 + \delta_d^2 + \delta_g^2$
- The probe size (and resolution) is, ultimately limited by the lens aberrations.



- > Typical values:
 - SEM ~2-10 nm
 - TEM/STEM 0.1-1 nm
- Recent efforts to compensate for the spherical aberrations have lead to improvements. best resolution to date
 - SuperSTEM resolution <0.08 nm. See later</p>

Contrast mechanisms

There are many contrast mechanisms. Here we mention a few.

Mass-thickness and Z-contrast

Recall that electrons scatter from other charges. Rutherford scattering from nuclear charge and core electrons will be greater for high-Z atoms (heavy materials), than for low-Z atoms (light materials).



Imaging (TEM) with the elastically scattered electrons leads to a Z-contrast image. A similar effect gives contrast with thick samples, i.e. in SEM. Sometimes called stopping-power contrast.



Here, the stronger scattering from high-Z materials creates secondary electrons closer to the surface. They have an increased change of escape and hence appear brighter.



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Diffraction contrast

Apertures located in the diffraction plane can select specific diffraction channels giving brightfield and dark-field imaging, as in optical microscopy.



Cardiac Mice cells, fixed in glutaraldehyde, and osmium tetroxide, bulk stained in uranyl acetate,. Scale bar is 4mm

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Topographic contrast

- The number of secondary electrons escaping in an SEM depends on the topography. The argument is similar to that for stopping-power (Z-contrast).
- Secondaries are created in a small volume, close to the surface, and the number that lie within the escape depth determine the brightness of the secondary electron image.
- Comparing normal and grazing incidence illustrates the point. A greater part of the secondary



volume lies within the escape depth away from normal incidence.





Some problems

- The microscope must be in a vacuum to transport electrons.
- Samples, in conventional instruments, must be compatible with the vacuum. i.e. dry/inorganic.
- We also require conducting samples since the current deposited in the sample must be part of a complete circuit. Sa



Figure, below, shows image distortion when an insulating, alumina sphere, Al₂O₃, becomes charged by the beam, so that strong electrostatic field develop, in time, around the sphere.



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Environmental chambers, giving higher pressure around the sample, have recently allow the observation of wet and non-conducting samples.

Variable pressure SEM/ESEM

- > At higher pressures:
 - Charge accumulation at insulating surfaces is reduced through neutralisation with ions in the gas (i.e. return path for the current is through the gas).

Beam



Specimen chamber There is cascade amplification of the secondary electrons. An environment saturated with

1-10 mbar

Pumping

Flectron

gun and

lenses

water vapour aids all the above

The Variable Pressure SEM (also known as Environmental ESEM) allows imaging of a variety of biological, insulating and soft-matter systems.



Analytic microscopy

Microanalysis

So far we have discussed images derived from elastically scattered and secondary electrons. Other signals give spectroscopic information:

X-ray emission:

- Measurement of the energy of characteristic xrays emitted by a sample is a standard feture of many SEM/TEM machines.
- Illustration is from a sample of a doped superconductor, YBCO. The "light" phase and "dark" phase regions, seen in the left image, have different chemical constituents (see panels on the right) Dark phase





Electron energy loss

Electron energy loss (EELS) is an alternative spectroscopic tool.

In TEM, measurements of the energy of the electron, after passing through the sample, indicate the inelastic scattering processes.

Process	Energy Loss (eV)	θ_{E} (mrad)
Phonons	~0.02	5-15
Plasmons	5-25	<-0.1
Inter/Intra-band transitions	5-25	5-10
Inner-shell ionization	~10-1000	1-5

Plasmon losses dominate in metallic systems. At higher energies core excitations occur (c.f. EXAFS spectra).



Recent developments I

Aberration corrected imaging, SuperSTEM

The idea is to compensate for positive spherical aberration, $C_s>0$, using a lens with a negative coefficient, $C_s<0$. One cannot do this with a cylindrically symmetric lens since all known systems have $C_s>0$. It can, however, be done with combinations of multipole (quadrupole/octopole) lenses.



Recent developments II

3-D imaging: Dual beam FIB/SEM

Focussed Ion Beam (FIB) selectively erodes the sample while SEM records images. From the 2-D images a 3-D image can be reconstructed



2-D images





Courtesy FEI

